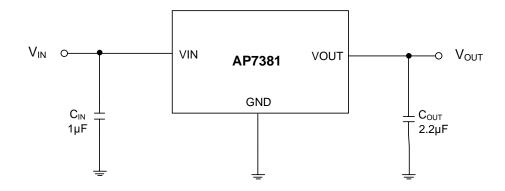


Typical Applications Circuit



Pin Descriptions

Pin Number			Pin Name	Function
TO92 (Ammo Packing)	SOT89	SOT23	Fili Naille	Function
3	3	1	VIN	Input voltage
2	2	3	GND	Ground
1	1	2	VOUT	Regulated output voltage

Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating		Unit
Vin	Supply Input Voltage	-0.3 to 45		V
Vouт	Output Voltage	-0.3 to 8		V
Іоит	Output Current	150		mA
T _{LEAD}	Lead Temperature (Soldering, 10s)	+260	+260	
TJ	Operating Junction Temperature	+150	+150	
	Thermal Resistance	SOT89	125	
θμα		TO92 (Ammo Packing)	165	°C/W
		SOT23	167	
T _{STG}	Storage Temperature Range	-65 to +150		°C
CDM	ESD (Change Device Model)	2000	2000	
HBM	ESD (Human Body Model)	4000		V

Note:

- a). Stresses beyond those listed under Absolute Maximum Ratings can cause permanent damage to the device. These are stress ratings only, and
 functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods can
 affect device reliability.
 - b. Ratings apply to ambient temperature at +25°C. The JEDEC High-K board design used to derive this data is a 2inch × 2inch multi-layer board with 1oz internal power and ground planes and 2oz copper traces on the top and bottom of the board.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
VIN	Supply Input Voltage	3.3	40	V
TJ	Operating Junction Temperature	-40	+125	°C



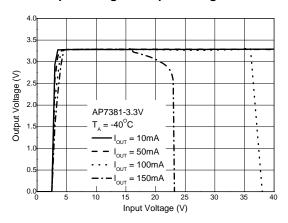
Electrical Characteristics (T_J = +25°C, I_{OUT} = 1mA, C_{IN} = 1.0 μ F, C_{OUT} = 2.2 μ F, V_{IN} = V_{OUT} + 2V, **Bold** typeface applies over -40°C \leq T_J \leq +125°C, unless otherwise specified.)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Vouт	Output Voltage	Variation from Specified Vout	Vоитх98%	_	Vоυтх102%	V
VIN	Input Voltage	_	3.3	_	40	V
ILIMIT	Current Limit	Vout = 98%xVout, Vin = Vout + 2V	150	_	_	mA
ΔVουτ/ΔVιν	Line Regulation	V _{OUT} + 2V ≤ V _{IN} ≤ 40V, I _{OUT} = 10mA	_	0.05	_	%/V
ΔVουτ/Vουτ	Load Regulation	1mA ≤ I _{OUT} ≤ 150mA	_	0.5	_	%
VDROP	Dropout Voltage	Iout = 100mA @ Vout = 3.3V	_	1000	_	mV
		Iout = 0A	_	2.5	_	_
IGND	Ground Current	IOUT = 100mA	_	25	_	μA
ΔVουτ/(VουτxΔΤ)	Output Voltage Temperature Coefficient	I _{OUT} = 100μA, -40°C ≤ T _J ≤ +125°C	_	±100	_	ppm/°C
T _{OTSD}	Thermal Shutdown Temperature	_	_	+160	_	°C
THYOTSD	Thermal Shutdown Hysteresis	_	_	+20	_	°C
PSRR	Power Supply Rejection Ratio	IOUT = 1mA, VOUT = 3.3V	_	60	_	dB

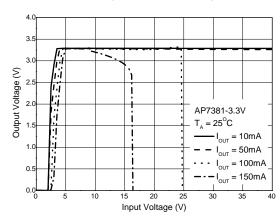


Performance Characteristics

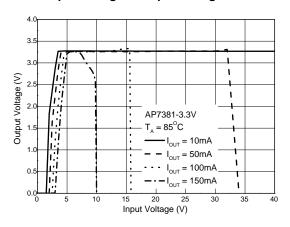
Output Voltage vs. Input Voltage @-40°C



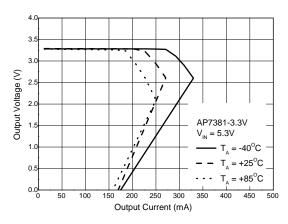
Output Voltage vs. Input Voltage @+25°C



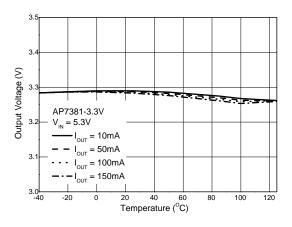
Output Voltage vs. Input Voltage @+85°C



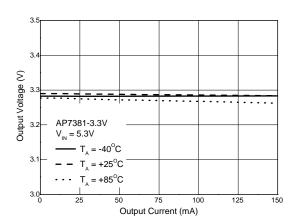
Output Voltage vs. Output Current



Output Voltage vs. Temperature



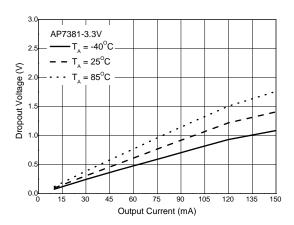
Output Voltage vs. Output Current



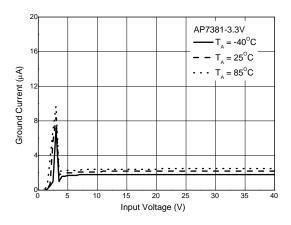


Performance Characteristics (continued)

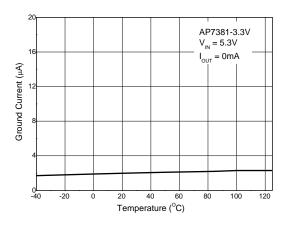
Dropout Voltage vs. Output Current



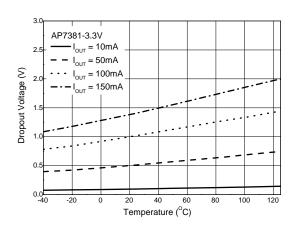
I_{GND} vs. Input Voltage



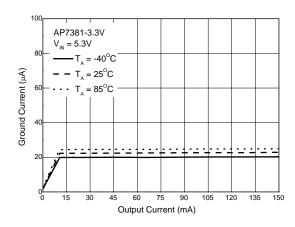
I_{GND} vs Temperature



Dropout Voltage vs. Temperature

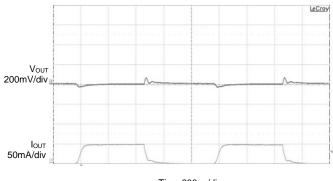


IGND vs. Output Current



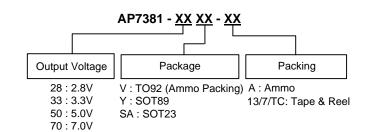
Load Transient

CIN=1µF, COUT=2.2µF, VIN=VOUT+2V, IOUT=0 to 50mA





Ordering Information (Note 5)



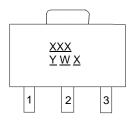
Part Number	Dookses Code	Packaging	Tape and F	Reel/Ammo
Fait Number	Package Code	Packaging -	Quantity	Part Number Suffix
AP7381-28V-A	V	TO-92 (Ammo Packing)	2000/Ammo	-A
AP7381-33V-A	V	TO92 (Ammo Packing)	2000/Ammo	-A
AP7381-50V-A	V	TO92 (Ammo Packing)	2000/Ammo	-A
AP7381-70V-A	V	TO92 (Ammo Packing)	2000/Ammo	-A
AP7381-28Y-13	Y	SOT89	2500/Tape & Reel	-13
AP7381-33Y-13	Y	SOT89	2500/Tape & Reel	-13
AP7381-50Y-13	Y	SOT89	2500/Tape & Reel	-13
AP7381-70Y-13	Y	SOT89	2500/Tape & Reel	-13
AP7381-33Y-TC	Y	SOT89	4000/Tape & Reel	-TC
AP7381-28SA-7	SA	SOT23	3000/Tape & Reel	-7
AP7381-33SA-7	SA	SOT23	3000/Tape & Reel	-7
AP7381-50SA-7	SA	SOT23	3000/Tape & Reel	-7
AP7381-70SA-7	SA	SOT23	3000/Tape & Reel	-7

Note: $5. \ For packaging \ details, go \ to \ our \ website \ at \ https://www.diodes.com/design/support/packaging/diodes-packaging/.$

Marking Information

(1) SOT89

(Top View)



 \underline{XXX} : Identification Code \underline{Y} : Year: 0 ~ 9

<u>W</u>: Week: A ~ Z: 1 ~ 26 Week; a ~ z: 27 ~ 52 Week;

z Represents 52 and 53 Week

X: Internal Code

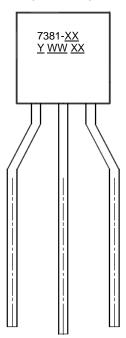
Part Number	Package	Identification Code
AP7381-28Y-13	SOT89	D9C
AP7381-33Y-13	SOT89	D9A
AP7381-50Y-13	SOT89	D9B
AP7381-70Y-13	SOT89	D9D
AP7381-33Y-TC	SOT89	D9A



Marking Information (continued)

(2) TO92 (Ammo Packing)

(Front View)



7381-XX: Identification Code

<u>Y</u>: Year: 0 ~ 9 <u>WW</u>: Week: 01 ~ 52; 52

Represents 52 and 53 Week XX : Internal Code

Part Number	Package	Identification Code
AP7381-28V-A	TO92 (Ammo Packing)	7381-28
AP7381-33V-A	TO92 (Ammo Packing)	7381-33
AP7381-50V-A	TO92 (Ammo Packing)	7381-50
AP7381-70V-A	TO92 (Ammo Packing)	7381-70

(3) SOT23

(Top View)

XXX: Identification Code

Y : Year 0 to 9

 \underline{W} : Week: A to Z: 1 to 26 week;

a to z: 27 to 52 week; z represents

52 and 53 week

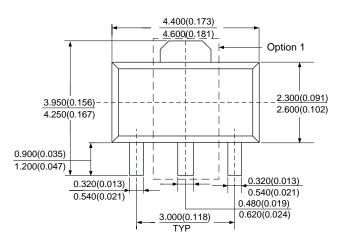
 \underline{X} : Internal Code

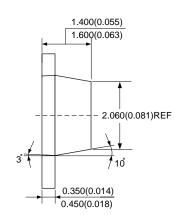
Part Number	Package	Identification Code
AP7381-28SA-7	SOT23	D9C
AP7381-33SA-7	SOT23	D9A
AP7381-50SA-7	SOT23	D9B
AP7381-70SA-7	SOT23	D9D

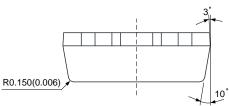


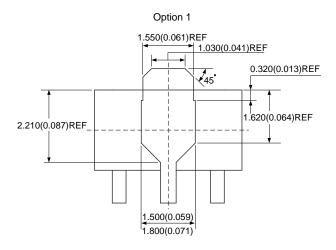
Package Outline Dimensions (All dimensions in mm.)

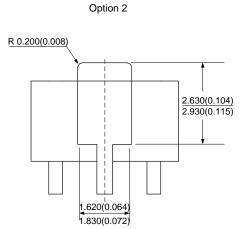
(1) Package Type: SOT89







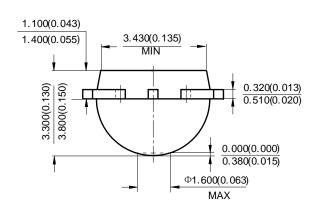


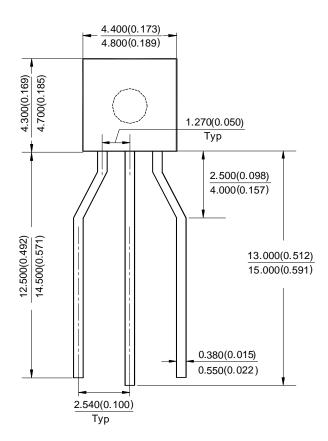




Package Outline Dimensions (All dimensions in mm.) (continued)

(2) Package Type: TO92 (Ammo Packing)

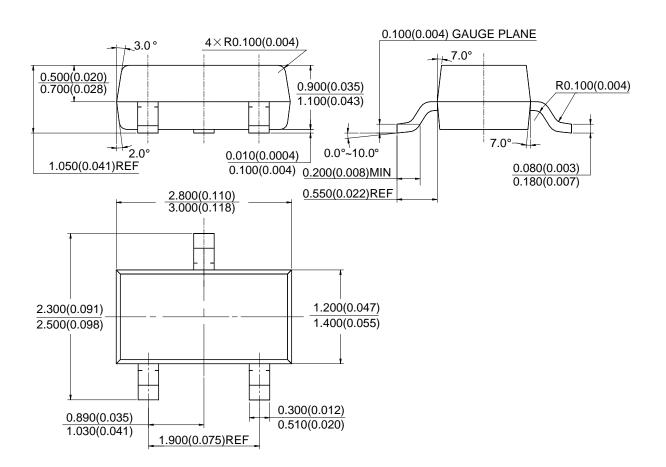






Package Outline Dimensions (All dimensions in mm.) (continued)

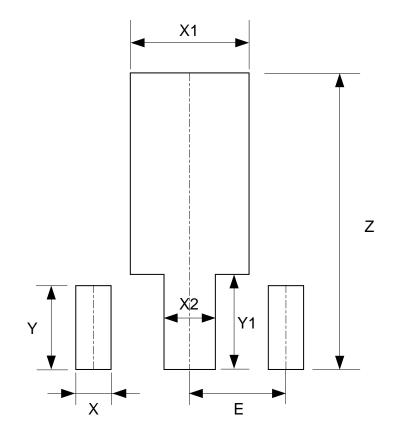
(3) Package Type: SOT23





Suggested Pad Layout

(1) Package Type: SOT89

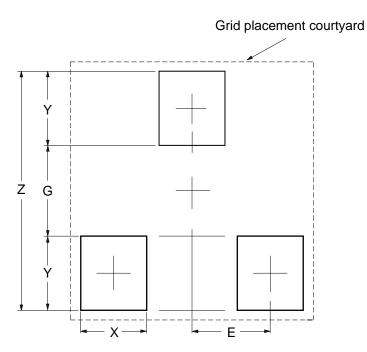


Dimensions	Z	X	X1	X2	Υ	Y1	E
Difficusions	(mm)/(inch)						
Value	4.600/0.181	0.550/0.022	1.850/0.073	0.800/0.031	1.300/0.051	1.475/0.058	1.500/0.059



Suggested Pad Layout (continued)

(2) Package Type: SOT23



Dimoneione	Z	G	X	Υ	E
Dimensions (mm)/(inch)		(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	2.900/0.114	1.100/0.043	0.800/0.031	0.900/0.035	0.950/0.037



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